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Part Number:

87832-3220

Status:

Active

Overview:

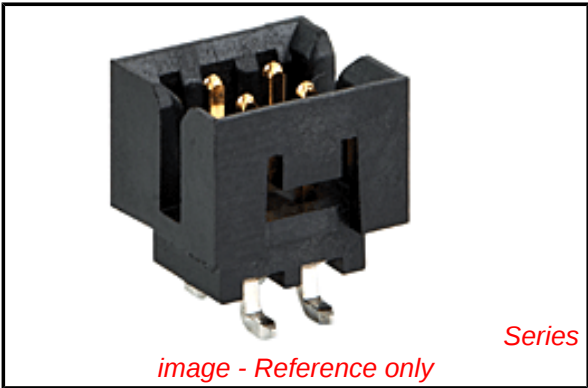
Milli-Grid™ Connector System

Description:

Milli-Grid™ Header, Surface Mount, Vertical, Shrouded, Lead-Free, 32 Circuits, 0.38µm Gold (Au) Plating, with Locking Windows and Centre Polarization Slot, PCB Locator, Tube

Documents:	
3D Model	Product Specification PS-87831-027 (PDF)
Drawing (PDF)	RoHS Certificate of Compliance (PDF)

Agency Certification	
CSA	LR19980
UL	E29179
General	
Product Family	PCB Headers
Series	87832
Application	Signal, Wire-to-Board
Comments	Contact Molex for application in automotive industry
Overview	Milli-Grid™ Connector System
Product Name	Milli-Grid™
UPC	822348273263
Physical	
Breakaway	No
Circuits (Loaded)	32
Circuits (maximum)	32
Color - Resin	Black
Durability (mating cycles max)	100
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Compliant	No
Guide to Mating Part	No
Keying to Mating Part	Yes
Lock to Mating Part	Yes
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	Nylon
Net Weight	1.408/g
Number of Rows	2
Orientation	Vertical
PCB Locator	No
PCB Retention	None
Packaging Type	Tube
Pitch - Mating Interface	2.00mm
Pitch - Termination Interface	2.00mm
Plating min - Mating	0.381µm
Plating min - Termination	1.905µm
Polarized to PCB	No
Shrouded	Fully
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-55°C to +105°C
Termination Interface: Style	Surface Mount



EU RoHS

ELV and RoHS Compliant

REACH SVHC

Contains SVHC: No

Low-Halogen Status

Not Low-Halogen

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com

For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

87832Series

Mates With

50394 Wire-to-Board Terminals, 51110 Wire-to-Board Crimp Housing, 87568 Wire-to-Board IDT Housings, 79107 Board-to-Board Top Entry Through Hole Receptacle, 79108 Board-to-Board FFC/FPC Top Entry Through Hole Receptacle, 79109 Board-to-Board Surface Mount PCB Receptacle

Electrical

Current - Maximum per Contact	2.0A
Voltage - Maximum	125V

Solder Process Data

Duration at Max. Process Temperature (seconds)	10
Lead-free Process Capability	Reflow Capable (SMT only)
Max. Cycles at Max. Process Temperature	1
Process Temperature max. C	260

Material Info

Reference - Drawing Numbers

Product Specification	PS-87831-027
Sales Drawing	SD-87832-006

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